

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Takashi ITO	12/15/2005
Tsuneo HAGIWARA	12/15/2005
Hideki KIMURA	12/15/2005
Masashi DATE	12/15/2005
Jiro YAMAMOTO	12/15/2005

RECEIVING PARTY DATA

Name:	CMET Inc.
Street Address:	5-5, Shinyokohama 2-chome, Kouhoku-ku
City:	Yokohama-shi, Kanagawa
State/Country:	JAPAN
Postal Code:	222-0033

Name:	San-Apro Ltd.
Street Address:	11, Ikkyo Nomoto-cho, Higashiyama-ku
City:	Kyoto-shi, Kyoto
State/Country:	JAPAN
Postal Code:	605-0995

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	10562098

CORRESPONDENCE DATA

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CH \$40.00 10562098

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NAME OF SUBMITTER:	Sheryl R. Neumann
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JOINT

ASSIGNMENT

WHEREAS, we, **Takashi ITO** and **Tsuneo HAGIWARA**, respectively citizens of **Japan**, with respective post office addresses of **c/o CMET Inc., 5-5, Shinyokohama 2-chome, Kouhoku-ku, Yokohama-shi, Kanagawa 222-0033 JAPAN**, and **Hideki KIMURA, Masashi DATE** and **Jiro YAMAMOTO** respectively citizens of **Japan**, with respective post office addresses of **c/o San-Apro Ltd., 11, Ikkyo Nomoto-cho, Higashiyama-ku, Kyoto-shi, Kyoto, 605-0995 JAPAN** hereinafter generally referred to as "ASSIGNORS," have invented a certain new and useful

ACTINIC RADIATION-CURABLE STEREOLITHOGRAPHIC RESIN COMPOSITION
HAVING IMPROVED STABILITY

for which we have executed a United States patent application, Application No. 10/562,098, filed December 21, 200 5 and

ASSIGNORS authorize ASSIGNEE or ASSIGNEE's representative to insert the Application Number and Filing date of this application if they are unknown at the time of execution of this Assignment.

WHEREAS, **CMET Inc.**, a Japanese corporation having a place of business at **5-5, Shinyokohama 2-chome, Kouhoku-ku, Yokohama-shi, Kanagawa 222-0033 JAPAN**, and **San-Apro Ltd.**, a Japanese corporation having a place of business at **11, Ikkyo Nomoto-cho, Higashiyama-ku, Kyoto-shi, Kyoto, 605-0995 JAPAN** hereinafter generally referred to as "ASSIGNEE", is desirous of acquiring said invention and said patent application.

NOW, THEREFORE, in consideration of the sum of One Dollar and other good and valuable executed consideration, the full receipt and sufficiency of all of which are hereby acknowledged and intending to be legally bound hereby, we, the undersigned ASSIGNORS, hereby agree to sell, assign, transfer and convey and by these presents do sell, assign, transfer and convey unto the above-named ASSIGNEE, the whole and entire right, title and interest

in and to said invention as described in the above patent application, for the territory of the United States and its possessions and territories and all foreign countries;

in and to the above patent application and any and all related United States and foreign patent applications disclosing said invention, including provisionals, non-provisionals, divisions and continuations thereof, along with all rights of priority created by said patent application under any treaty relating thereto; and

in and to all United States and foreign patents which may be granted on any and all of said patent applications, including extensions, reissues and reexamination certificates thereof;

said invention, application(s) and patent(s) to be held and enjoyed by the above-named ASSIGNEE, for ASSIGNEE's own use and benefit, and for ASSIGNEE's legal representatives and assigns to the full end of the term or terms for which said patent(s) may be granted, as fully and entirely as the same would have been held by the undersigned ASSIGNORS had this assignment and sale not been made; and for the aforesaid consideration ASSIGNORS hereby covenant, agree and undertake to execute, whenever requested by the above-named ASSIGNEE, all patent applications, assignments, lawful oaths and any other papers which ASSIGNEE may deem necessary or desirable for securing to ASSIGNEE or for maintaining for ASSIGNEE all the patent(s) hereby assigned or agreed to be assigned; all without further compensation to the undersigned ASSIGNORS.

<u>December 15, 2005</u> Date	<u>Takashi Ito</u> (Seal) Takashi ITO
<u>December 15, 2005</u> Date	<u>Tsuneo Hagiwara</u> (Seal) Tsuneo HAGIWARA
<u>December 15, 2005</u> Date	<u>Hideki Kimura</u> (Seal) HIDEKI KIMURA
<u>December 15, 2005</u> Date	<u>Masashi Date</u> (Seal) Masashi DATE
<u>December 15, 2005</u> Date	<u>Jiro Yamamoto</u> (Seal) Jiro YAMAMOTO